



REACH Certificate of Compliance

This is to certify that all the parts listed in Annex-1 below do not contain more than 0.1% of product weight for each of 240 substances which are announced by ECHA as “Substances of Very High Concern (SVHC)” and our parts are compliant to REACH ANNEXVII.

Note:

The products that marked (*) in Annex-1 contain Diphenyl(2,4,6-trimethylbenzoyl)phosphine oxide(CAS#75980-60-8), now are listed as a Substance of Very High Concern (SVHC). In addition, the concentration value is less than 0.1%.

Coreworks Product Name: Inductors

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Annex-1

REACH Compliance by Part Number

Part Number	Description
RT -Series	Thin Film Chip Inductor
SM-F Series	Multilayer Chip Inductor
XM-Series*	Wire Wound Chip Inductor
XMM-Series*	Wire Wound Chip Inductor
LKI-Series	Multilayer Chip Bead
LKI-Series	Multilayer Chip Beads
SPO-Series	SMD Power Inductor
SPM-Series	Shielded SMD Power Inductor
FCG-Series	Multilayer Ferrite Chip Inductor
FCG-G Series	Multilayer Ferrite Chip Inductor
LWG-Series	Wire Wound Chip Inductor(Ferrite /Open Type)
FCP-Series	Wire Wound Type Power Inductor
XLPS-A-Series	Thin Film Chip Inductor (Auto grade)
XLPS-Series	Thin Film Chip Inductor (Commercial grade)
LMG-Series	Non-shielded, High Power, Wire Wound Power Inductor
XLPF-Series	Shielded SMD Power Inductor
XLPC-Series	Power Choke Power Inductor
SFW-Series	Non-shielded, High Power, Wire Wound Power Inductor